

1. Record Nr.	UNINA9910957865803321
Titolo	IUTAM Symposium on Advanced Optical Methods and Applications in Solid Mechanics : proceedings of the IUTAM Symposium held in Futuroscope, Poitiers, France, August 31st - September 4th 1998 // edited by Alexis Lagarde
Pubbl/distr/stampa	New York, : Kluwer Academic, c2000
ISBN	1-280-20513-X 9786610205134 0-306-46948-0
Edizione	[1st ed. 2002.]
Descrizione fisica	1 online resource (681 p.)
Collana	Solid mechanics and its applications ; ; v. 82
Altri autori (Persone)	LagardeAlexis
Disciplina	620.11
Soggetti	Strength of materials Optical measurements Photoelasticity Image analysis
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Description based upon print version of record.
Nota di bibliografia	Includes bibliographical references and index.
Nota di contenuto	METHODS -- Static and Dynamic Strain Measurement on a Plane Surface. Three-dimensional Photoelasticity / A. Lagarde -- Phase Measurement Method for Stress Analysis from Photoelastic Data / J. A. Quiroga, A. González-Cano -- Generalized Phase-shifting Method for Measuring Photoelastic Fringe Parameters and its Applications / E. Umezaki, Y. Nanka -- Interference Blots in Integrated Fringe Patterns / H. Aben, L. Ainola -- Visualisation of Photoelastic Fringes Within Three Dimensional Specimens Using an Optical Slicing Method / N. Plouzennec, J. -C. Dupré, A. Lagarde -- Optical Approaches of a Photoelastic Medium for Theoretical and Experimental Study of the Stresses in a Three-dimensional Specimen / A. Zenina, J. C. Dupré, A. Lagarde -- An Approach to General 3-D Stress Analysis by Multidirectional Scattered Light Technique / Takahiro Oi, Masahisa Takashi -- Plotting of Isochromatic and Isostatic Patterns of Slice Optically Isolated in a Three Dimensional Photoelastic Model / A. Zenina, J. C. Dupré, A. Lagarde -- A Study on Stress Freezing Method

Based on Time and Temperature Dependent Photoviscoelastic Behaviors / S. Sugimori, Y. Miyano, T. Kunio -- The Assessment of the T^* Fracture Parameter During Creep Relaxation / C. Walker, P. Mc Kenzie -- Temperature Insensitive Moiré Interferometry : A Quantitative Investigation / J. Mc Kelvie, G. Collin -- Theory of Moiré Fringe Formation with an Electron Beam / D. T. Read, J. W. Dally -- A Geometrical Interpretation of the Tensorial Characterisations of Finite Strains / P. Rougée -- Shape, Surface and Deformation Measurement: Scope and Trends / H. J. Tiziani -- Optical Measurement of Strain on Thin-film Polysilicon Tensile Specimens / William N. Sharpe Jr. -- Residual Stress Measurement with Optical Strain Rosettes / Keyu Li -- High Speed Local Strain Determination from Grating Diffraction / V. Valle, M. Cottron, A. Lagarde -- High Speed Measurement of Discontinuous Surface Profiles / J. M. Huntley, C. R. Coggrave -- Transient Stress Analysis Under Low Velocity Impact by White Light Photoviscoelastic Technique / S. Yoneyama, M. Takashi -- Speckle Interferometry / F. P. Chiang, F. Jin, Q. Wang, N. Zhu -- Use of Speckle Interferometry Under Extreme Thermal Conditions / P. Aswendt -- Speckle Interferometry Improvements for Applications in Civil Engineering / P. Jacquot, M. Lehmann, X. Colonna de Lega, M. Facchini -- Panoramic Interferometry / Leonid A. Borynyak, Eugene A. Krasnopevtsev -- Deformation Measurement and Analysis on Related Curved Surfaces by Holography / W. Schumann -- Interference of Fracture Surfaces Observed by Means of Optical Methods for the Cracks Subjected to Shear and Compression / M. Szpakowska, P. Pyrzanowski, J. Stupnicki -- Shearography in Experimental Mechanics and Nondestructive Testing / Y. Y. Hung -- Vibration Analysis by Means of Digital Speckle Pattern Shearing Interferometry (Digital Shearography) / W. Steinchen, L.X. Yang, G. Kupfer, P. Mäckel, F. Vössing -- Study of Sub-interfacial Quasi-static Crack Propagation Using Shearing Interferometry / Hansuk Lee, Sridhar Krishnaswamy -- Some Studies of Thermomechanical Behaviour of Solid Materials by Infrared Thermography / O. Maisonneuve, A. Chrysochoos -- Infrared Thermography of Thermomechanical Couplings in Solids / M. P. Luong, D. Parganin, J. Loizeau -- Automated Photoelasticity Applied With Thermoelasticity to Real Components / S. Barone, Z. F. Wang, E.A. Patterson -- Experimental Analysis of Localization Mechanisms in Mild Steels by Infrared and Speckle Image Processing / A. Chrysochoos, H. Louche, J. -M. Muracciole, M. Némoz-Gaillard, J. -L. Saurel, B. Wattrisse -- Hibrid Stress Analysis by Construction of Approximate Analytical Solution / M. Takashi, S. Mawatari -- Hybridizing Optical Methods with Analytical and Computational Techniques for Stress Analysis / R. E. Rowlands -- Hybrid Stress Analysis with Integrated Photoelasticity / H. Aben, L. Ainola -- TOOLS -- Digital Image Processing by Phase Shifting Method Using Fourier Transform / Y. Morimoto, M. Fujigaki -- Digital Image Comparator for Experimental Analysis of Deformations / L. Berka, J. Klima, M. Druckmüller, M. Sova -- Precise and Robust Phase Measurement Algorithms / M. F. Küchel -- Holographic photorefractive images storage for applied metrology by interferometry / Ph. C. Lemaire, M. P. Georges -- New Generation of Optical Ultrasonic Sensors Adapted to Industrial Constraints / Philippe Delaye, Gérald Roosen -- Adaptive Holographic Interferometry using Photorefractive Recording Media for Full-field Optical Mapping of Stress and Deformation Fields / B. Pouet, H. Tuovinen, S. Krishnaswamy -- Iterative Algorithms : An Alternative to Holography / A. Desfarges-Berthelemon, B. Colombeau, C. Froehly, V. Kermene, M. Vampouille -- Coherent Images Amplified by Non Linear Optic Waves Mixing / E. Lantz, F. Devaux, G. Le

Tolguenec, E. Guiot, M. Müller -- Detection of Flaws in Materials by Laser-ultrasonics / J. -P. Monochalin, C. Néron, M. Choquet, A. Blouin, B. Reid, D. Lévesque et al. -- Applications -- An Extension of Holographic Moiré to Micromechanics / C. A. Sciammarella, F. M. Sciammarella -- Stereolithography and Micro-mechanics / Serge Monneret, Serge Corbel, Virginie Loubere -- Interference Displacement Measurement of Semiconductor Pressure Sensor / Tomasz Pancewicz

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APPLICATIONS -- Moiré Interferometry Analysis of Fracture / Albert S. Kobayashi -- The Stress Field Around Two Parallel Cracks in a Finite Geometry: A Hybrid Study Combining High-density Geometric Moiré and Photoelasticity with the Westergaard Approach and Local Collocation Methods / Ravinder Chona -- Solution of Fracture Problems by Non-linear Photoelastic Methods Under Large Elastic and Plastic Strains / Marat Akhmetzyanov, Galina Albaut, Viktor Baryshnikov -- Applications of Optical Methods of Stress Analysis to Study Fracture Phenomena / F. Ferber, K.P. Herrmann, K. Linnenbrock -- Active Control of Stress Intensity Factor K Under Mixed Mode Stress in The SMA-FEC / A. Shimamoto, Y. Furuya, E. Umezaki -- High Rate Shear Induced Failure in Solids / J.F. Kalthoff -- Dynamic Failure Investigation in Polymers / -- Z. Zhu, K. Ravi-Chandar -- Subsonic and Intersonic Interfacial Fracture: Dynamic Photoelastic Investigation / A. Shukla, M. Kavaturu -- Dynamic Behaviour of Interfacial Crack Tips in a Wedge-shaped Bimaterial Specimen Under Impact / J. Fang, C. Y. Xiong, X. F. Yao -- Measurement of Crack Tip Opening Displacement and Full-field Deformations During Fracture of Aerospace Materials Using 2D and 3D Image Correlation Methods / Michael A. Sutton, Stephen R. McNeill, Jeffrey D. Helm, Michael L. Boone -- Coherent-optical Study of Crack Propagation in Polymer Pipes After Impact / P. Boone, P. van Speybroeck, J. Degrieck, B. Verhegge, V. Markov -- Stress Field Measurement at Bifurcation of Fast Propagating Cracks by High-speed Interferometry / S. Suzuki, I. Inayama, N. Arai, T. Mizuta -- Optical Investigation of a Connecting-rod Big End Bearing Model Under Dynamic Loads / V. Optasanu, D. Bonneau -- Application of Infrared Thermography for Contact Problems / T. Sakagami, K. Ogura, S. Kubo, T. N. Farris -- Application of Geometric Moiré to the Analysis of Large Deformation in Three-dimensional Models / V. Cincinelli, C. Pappalettere, W. M. Sun, L. Surace -- The Combination of Speckle Correlation and Fringe Projection for the Measurement of Dynamic 3-D Deformations of Airbag Caps / Herbert Weber, Ralf Lichtenberger, Thomas Wolf -- Analysis of the Degradation Mechanisms in Composite Materials Through a Correlation Technique in White Light / Y. Berthaud, S. Calloch, F. Collin, F. Hild, Y. Ricotti -- Progress in Mechanics of Materials by Using Laser Speckle Method / F. Lagattu, J. Brillaud, M. C. Lafarie-Frenot -- Development of a Stereoscopic Optical Strain Measurement Technique: Application of Maize Roots / S. Denis, F. Bremand -- Measurement of Residual Deformations Induced by High Temperature Load / N. Cavallo, F. Morestin, J.F. Jullien -- Conclusion : IUTAM Symposium Advanced Optical Methods and Applications in Solid Mechanics / J.W. Dally.

Sommario/riassunto

The request to organize under its patronage at Poitiers in 1998 a Symposium entitled "Advanced Optical Methods and Applications in Solid Mechanics" by the International Union of Theoretical and Applied Mechanics (I.U.T.A.M.) was well received for the following two reasons. First, for nearly 20 years no Symposium devoted to optical methods in solids had been organized. Second, recent advances in digital image processing provided many new applications which are described in the following. We have the honour to present here the proceedings of this

Symposium. The Symposium took place from August 31 to September 4 at the Institut International de la Prospective in Futuroscope near Poitiers. A significant number of internationally renowned specialists had expressed their wish to participate in this meeting. The Scientific Committee proposed 16 general conferences and selected 33 regular lectures and 17 poster presentations. Papers corresponding to posters are not differentiated in the proceedings from those that were presented orally. It is worth noting that a total of 80 participants, representing 16 countries, registered for this symposium. The Scientific Committee deserves praise for attracting a significant number of young scientists, both as authors and as participants. Let us add our warm acknowledgements to Professor J.W. Dally and to Professor A.S. Kobayashi who, throughout the symposium preparation time, brought us valuable help.
